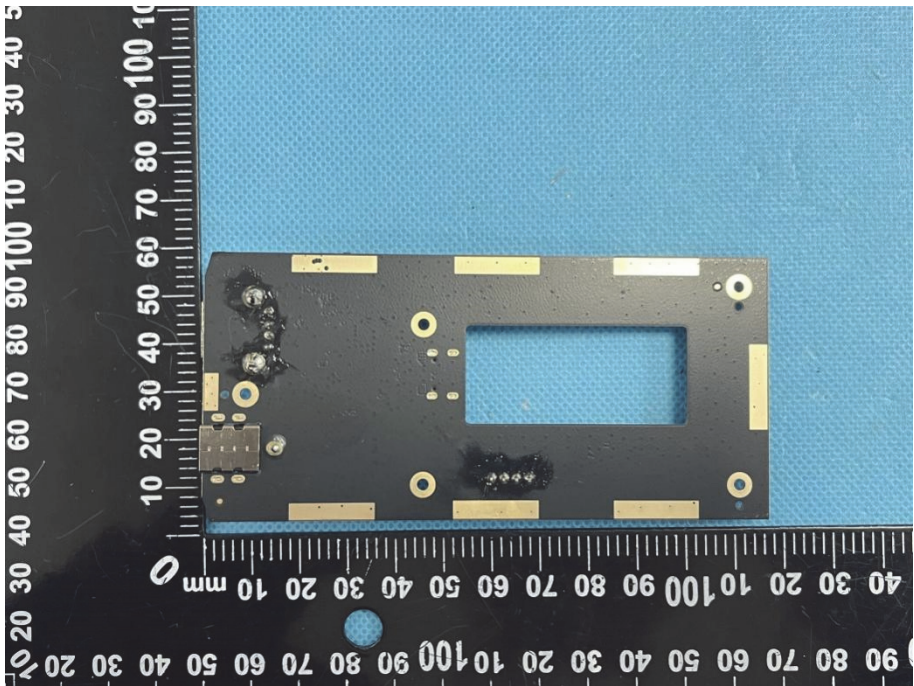
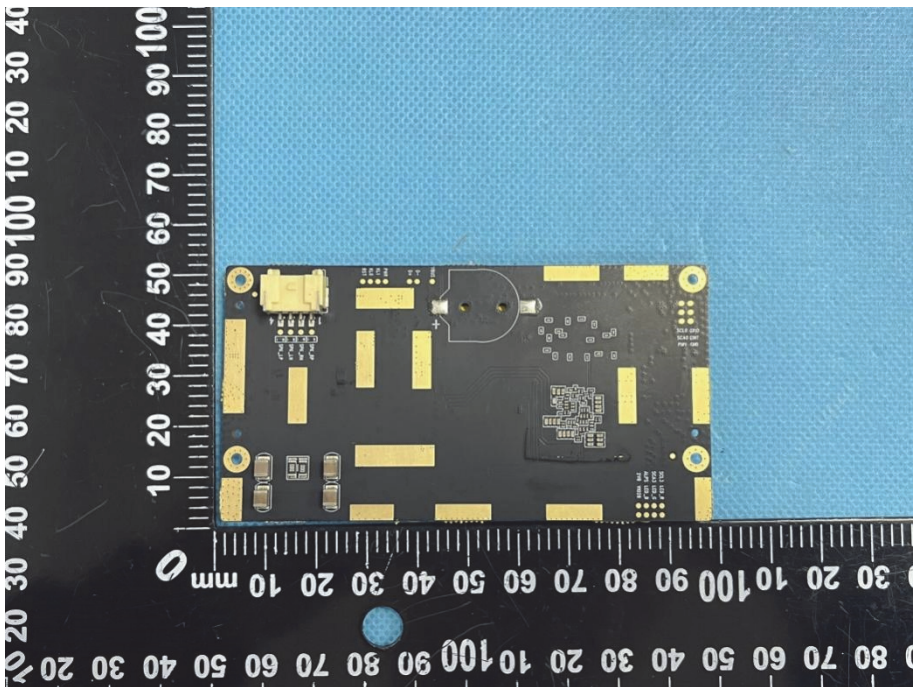
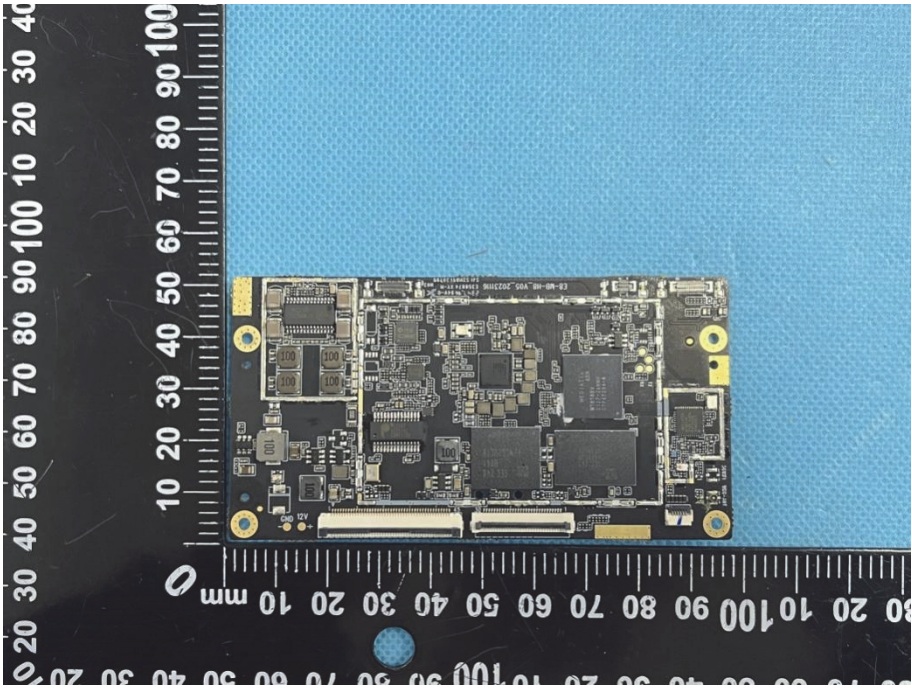
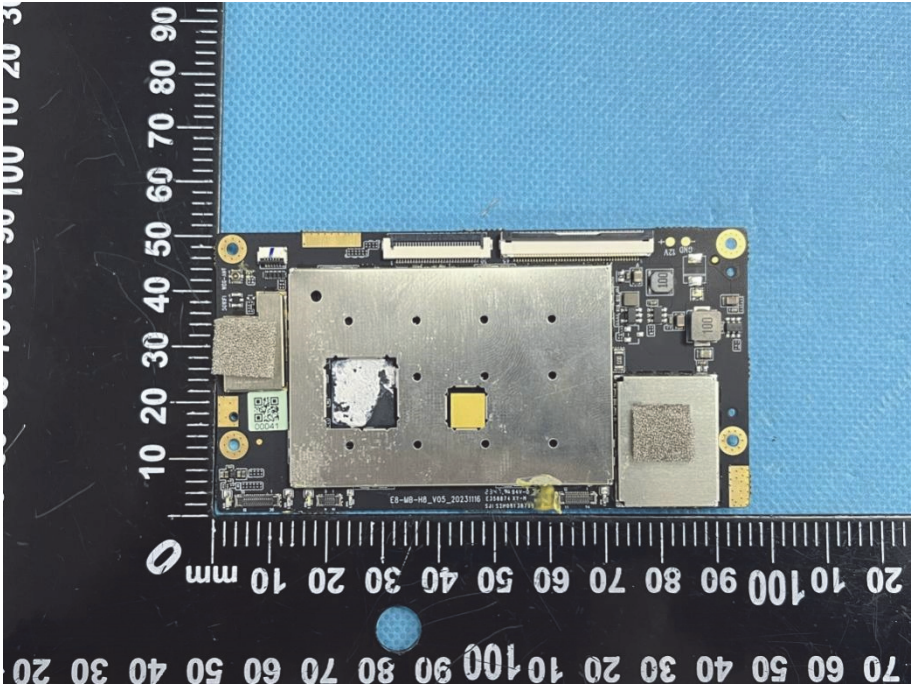
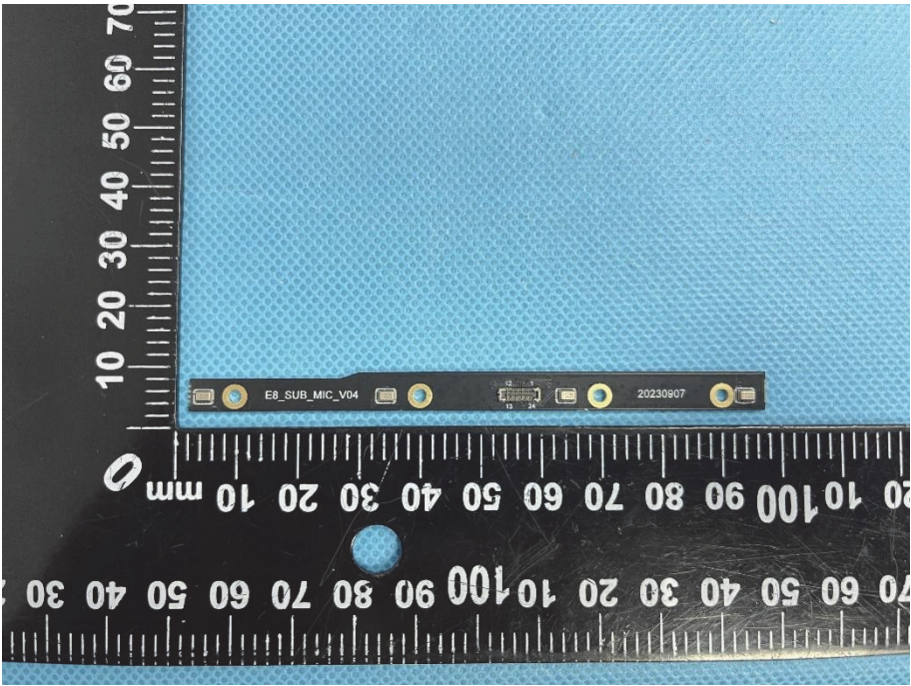
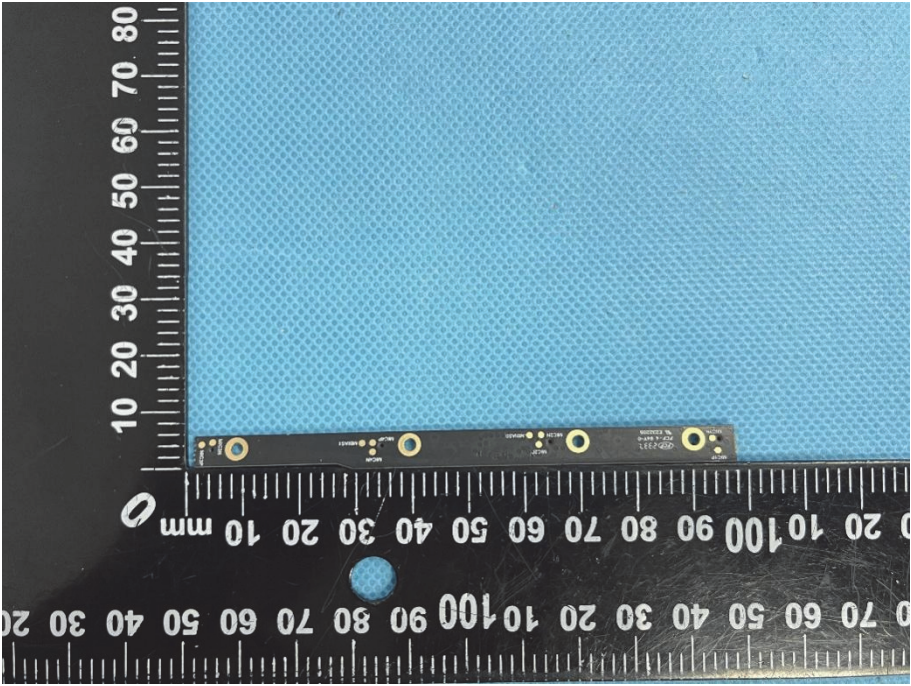
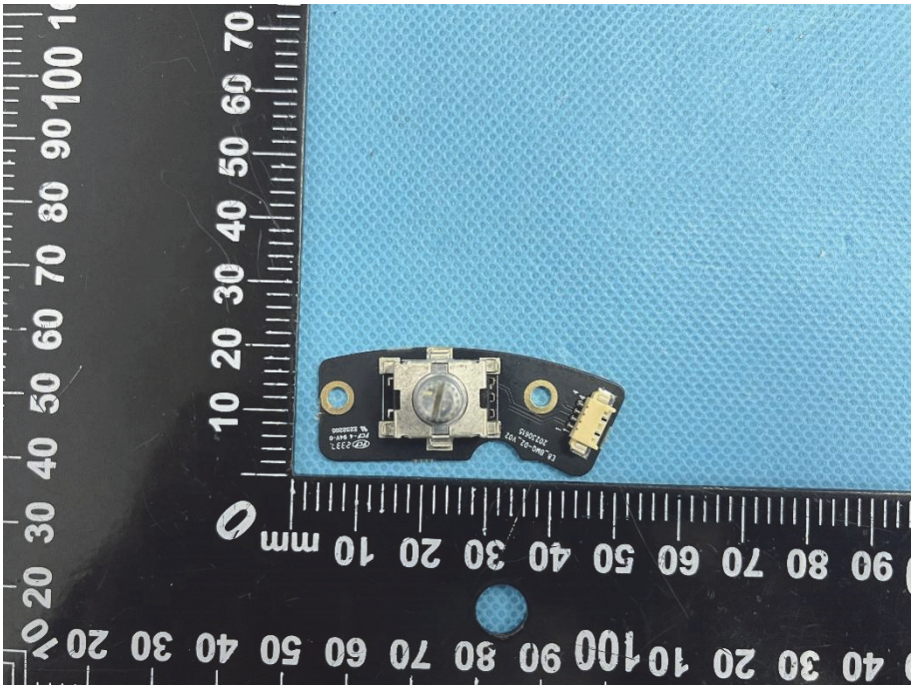
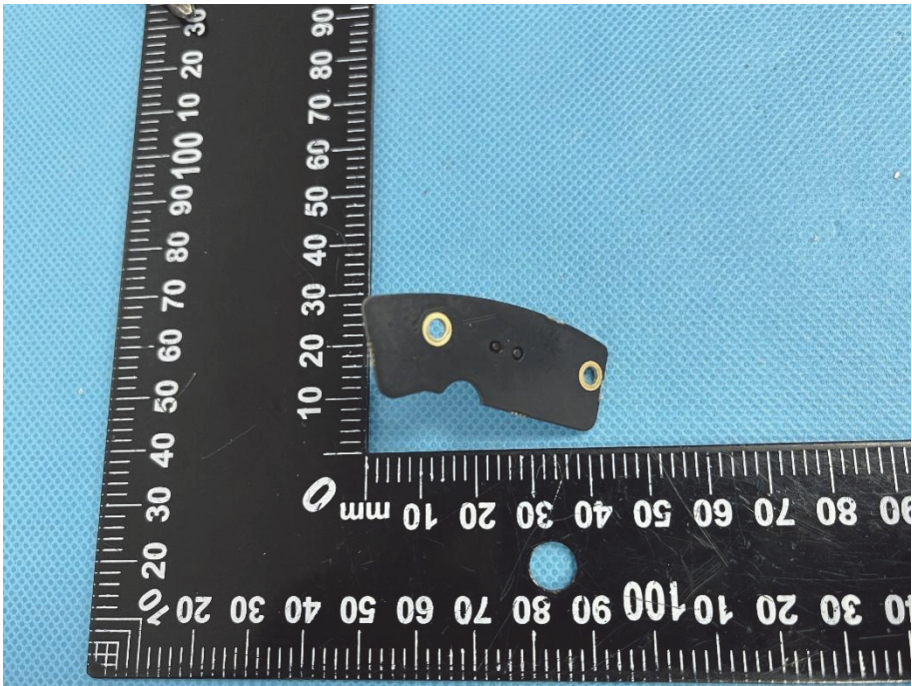


Solder Board-Component View 10	 A photograph of a black printed circuit board (PCB) with a rectangular cutout in the center. The board is populated with several components, including a multi-pin connector on the left edge, several small surface-mount components, and four circular mounting holes. The board is placed on a blue textured surface next to a black metric ruler with white markings. The ruler shows dimensions in millimeters, with the board's width being approximately 100 mm and its height approximately 60 mm.
Solder Board-Component View 11	 A photograph of the same black PCB from a different angle, showing the underside. This view reveals the solder joints and the reverse side of the components, including a large integrated circuit (IC) in the center, various passive components, and the connector on the left. The board is again placed on a blue textured surface next to a black metric ruler for scale. The ruler indicates the board's dimensions are consistent with View 10.

Solder Board-Component View 12	 A photograph of a rectangular printed circuit board (PCB) populated with various electronic components, including integrated circuits, capacitors, and resistors. The board is positioned against a blue background. A black ruler with white markings is placed vertically to the left of the board, showing measurements in millimeters from 0 to 100. The board's components are densely packed, and the solder joints are visible.
Solder Board-Component View 13	 A photograph of the same rectangular printed circuit board (PCB) from a different perspective. This view shows a large, central, rectangular component, possibly a heat sink or a large integrated circuit, which is covered with a silver-colored material. The board is surrounded by other components and solder joints. A black ruler with white markings is placed vertically to the left of the board, showing measurements in millimeters from 0 to 100. The background is blue.

Solder Board-Component View 14	 A photograph of a small electronic component, labeled 'E8_SUB_MIC_V04' and '20230807', mounted on a blue textured surface. The component is positioned horizontally next to a black ruler with white markings. The ruler shows measurements in millimeters, with the component spanning approximately from 10 mm to 100 mm. The component has several gold-colored solder points and a small black integrated circuit.
Solder Board-Component View 15	 A photograph of the same electronic component from a different angle, showing the underside or a different side. The component is still labeled 'E8_SUB_MIC_V04' and '20230807'. It is positioned horizontally next to a black ruler with white markings, similar to the previous view. The component's gold-colored solder points and the black integrated circuit are visible from this perspective.

Solder Board-Component View 16	 A photograph of a small, black, rectangular electronic component with a central metallic pad and two circular gold-plated pads on the left and right. It is placed on a blue textured surface next to a black ruler with white markings. The ruler shows dimensions in millimeters, with the component spanning approximately 20 mm in width and 10 mm in height.
Solder Board-Component View 17	 A photograph of the same black electronic component from a different angle, showing its profile and the two circular gold-plated pads. It is placed on a blue textured surface next to a black ruler with white markings. The ruler shows dimensions in millimeters, with the component spanning approximately 20 mm in width and 10 mm in height.

Antenna View

